

## PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT4283843

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
QIU SHA	02/09/2017
ANDREY MALININ	02/08/2017
QIFENG SHI	02/09/2017
MINGSHENG PENG	02/09/2017
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	DIALOG SEMICONDUCTOR INC.
<b>Street Address:</b>	675 CAMPBELL TECHNOLOGY PARKWAY
<b>Internal Address:</b>	SUITE 150
<b>City:</b>	CAMPBELL
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	95008
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15406651
<b>CORRESPONDENCE DATA</b>	
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<b>Address Line 4:</b>	DALLAS, TEXAS 75219
<b>ATTORNEY DOCKET NUMBER:</b>	52769.63US01 (2016-091)
<b>NAME OF SUBMITTER:</b>	JONATHAN W. HALLMAN
<b>SIGNATURE:</b>	/Jonathan W. Hallman/
<b>DATE SIGNED:</b>	02/21/2017
<b>Total Attachments: 2</b>	

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## ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, we

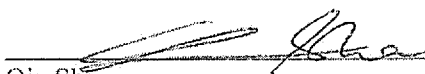
Qiu Sha of Campbell, California  
Andrey Malinin of Campbell, California  
Qifeng Shi of Campbell, California  
Mingsheng Peng of Campbell, California

hereby sell, assign and transfer to Dialog Semiconductor Inc., a California corporation, having a place of business at 675 Campbell Technology Parkway, Suite 150, Campbell, California 95008, its successors and assigns, the entire right, title and interest throughout the world in my invention in

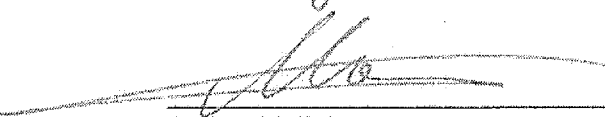
### LOW-POWER AND COMPACT VOLTAGE SENSING CIRCUIT

for which we filed a United States Patent Application on January 13, 2017 and given Serial Number 15/406,651, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; we authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; we agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, their successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and we request that the United States Patent and Trademark Office issue all patents granted for said invention to the above-named assignee, its successors and assigns.

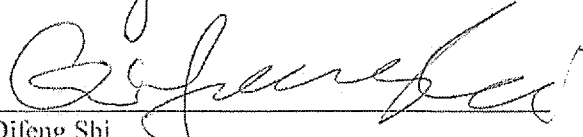
Executed this 9 day of February, 2017.

  
Qiu Sha

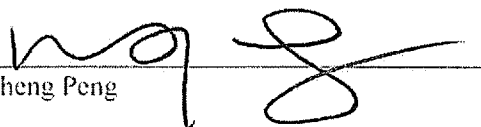
Executed this 8 day of February, 2017.

  
Andrey Malinin

Executed this 9 day of February, 2017.

  
Qifeng Shi

Executed this 9 day of February, 2017.

  
Mingsheng Peng